

### Features

- Stable and reliable performance
- Supports ISM 868 MHz Band
- Low Profile, Compact Size
- Low Temperature coefficient of frequency
- RoHs Complaint



### Applications

- ISM Band System
- RFID System

### Specifications

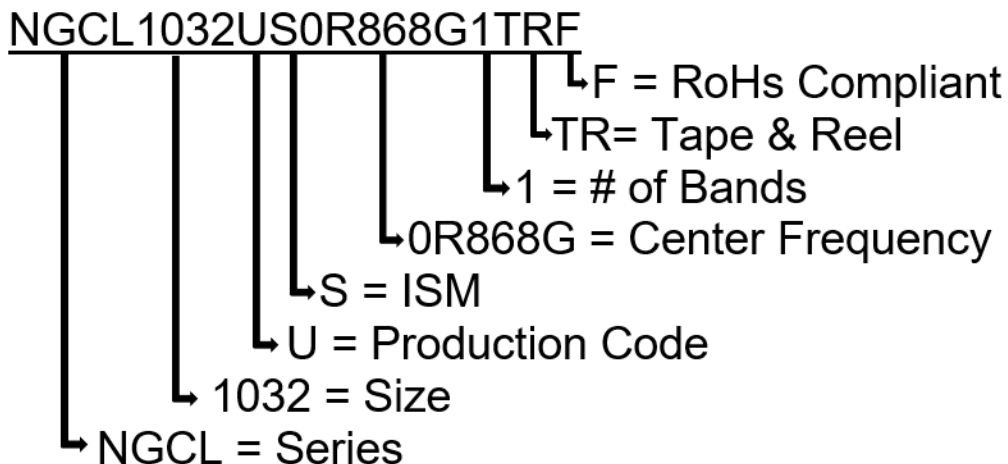
Electrical	
Frequency Range	863 ~ 870 MHz
Center Frequency	868 MHz
VSWR	2 Max.
Peak Gain	0.34 dBi Typ.
Efficiency	58%
Maximum Input Power	2 W
Polarization	Linear
Impedance	50Ω
Environmental	
Operating Temperature	-40°C~+85°C
Temperature Coefficient of Frequency	0 ± 20 max (@ -20°C ~ 80°C)
Storage Temperature	-5°C~+40°C -40°C~+85°C - After mounting on PCB
Relative Humidity	10% to 70% - Operating & Storage after mounting on PCB 20% to 70% - Storage
Shelf Life	1 year
RoHs Compliant	Yes

# NGCL1032US0R868G1TRF

868 MHz ISM Chip Antenna



## Part Number Breakdown



## Pin Definition



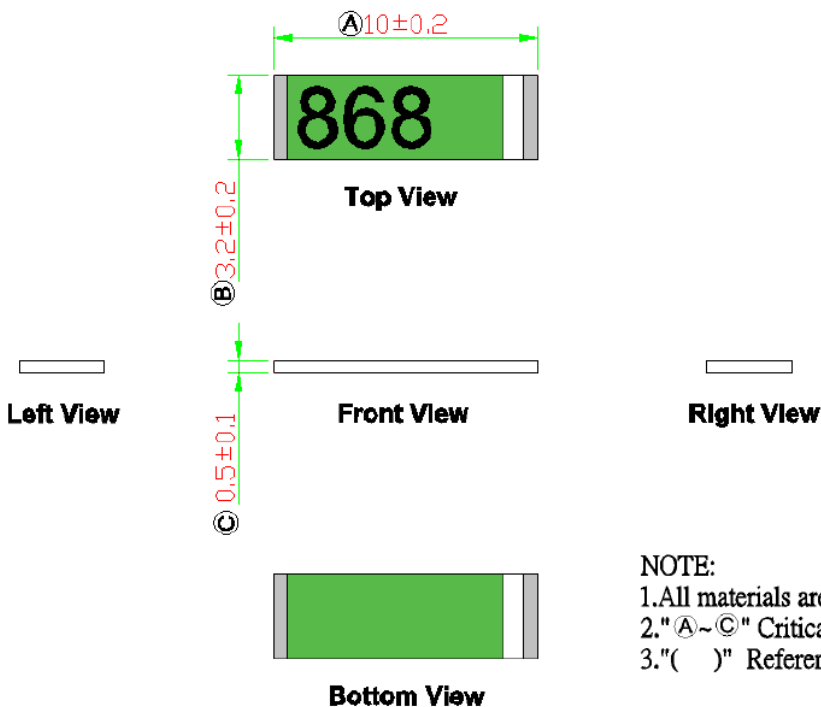
**Top View**



**Bottom View**

PIN	1	2
Soldering PAD	Signal	Tuning / Ground

### Dimension Drawing



#### NOTE:

1. All materials are RoHS 2.0 compliant.
2. "A"~"C" Critical Dimensions.
3. "( )" Reference Dimensions.

### Dimensions (mm) & Mechanical

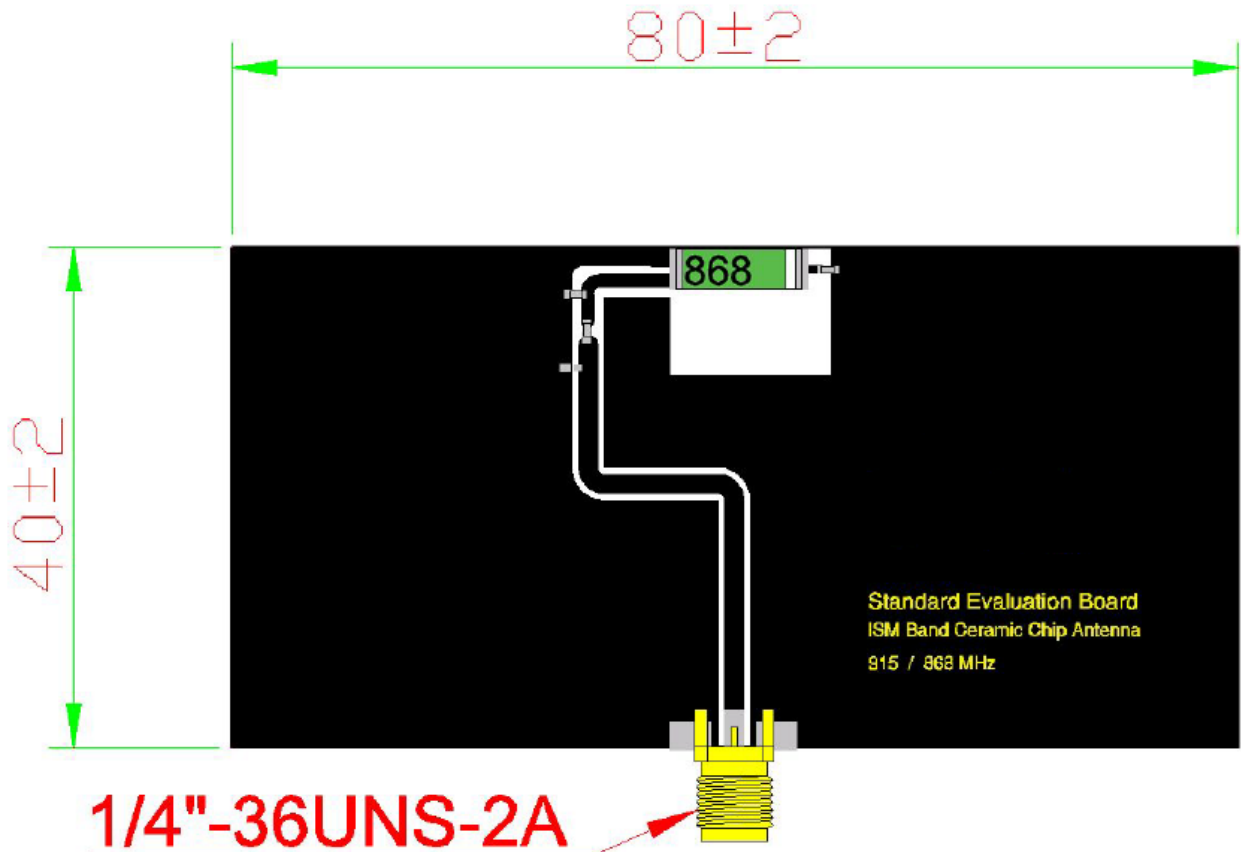
Body Length (A)	$10 \pm 0.2$
Width (B)	$3.2 \pm 0.2$
Thickness (C)	$0.5 \pm 0.1$
Connection Type	SMT
Ground Plane	80 mm x 40 mm
Material	Ceramic

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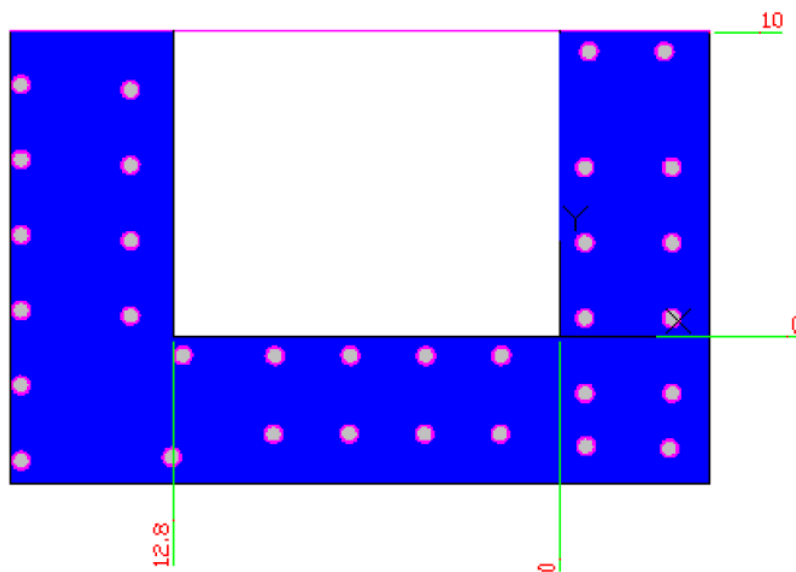
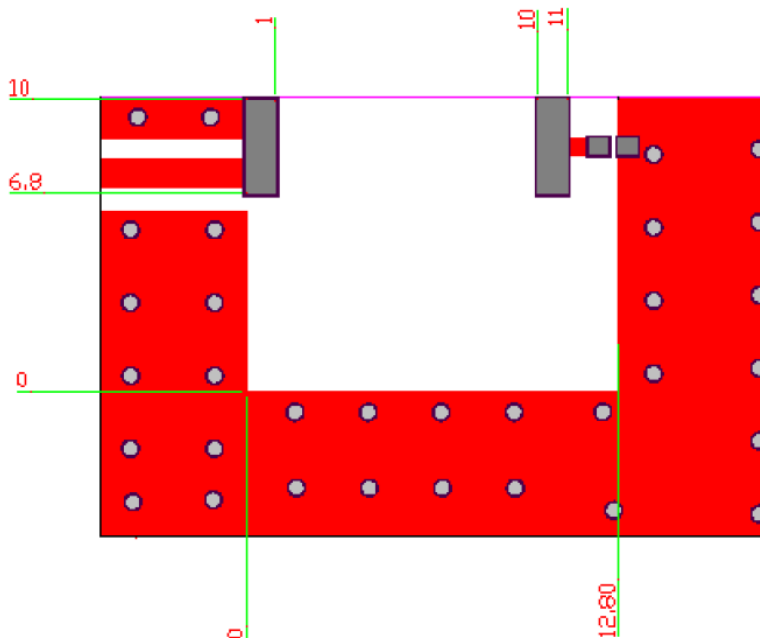
## Evaluation Board



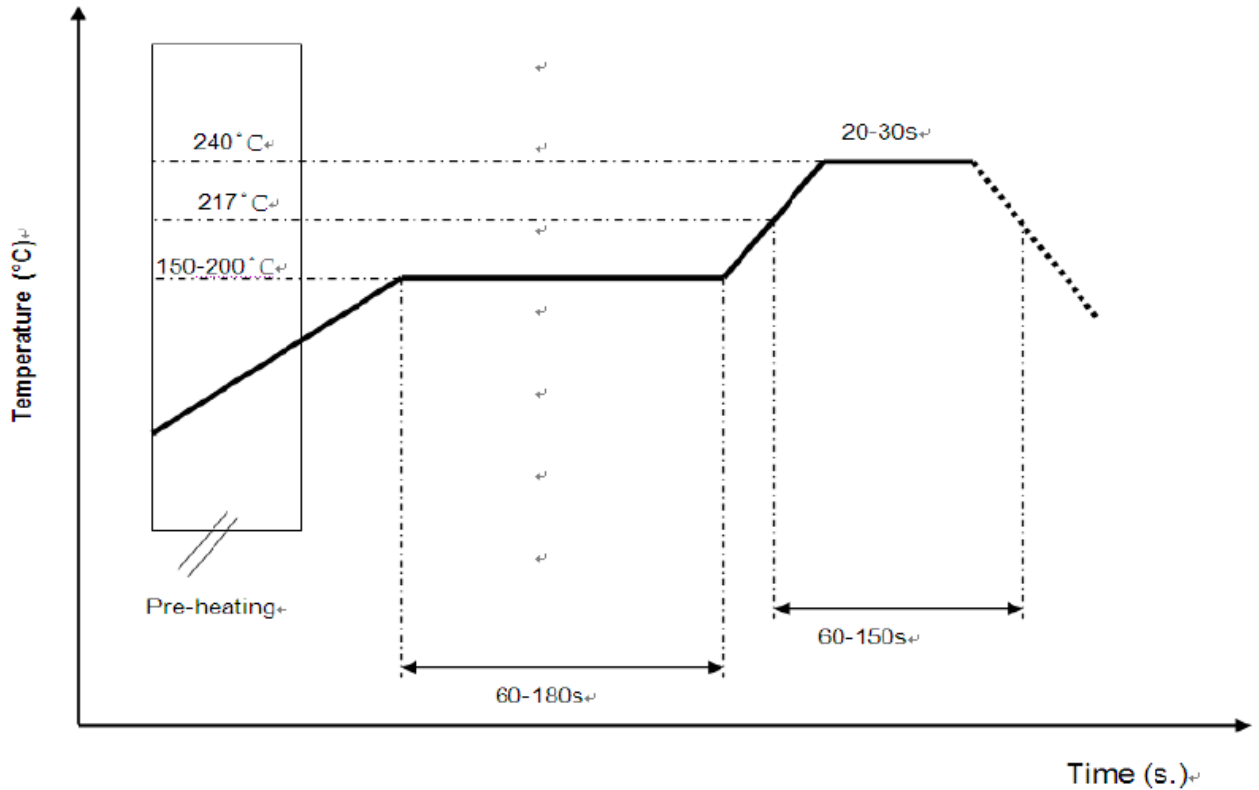
Unit : mm

### Solder Land Pattern

The gray areas represent the solder land pattern. Any recommendations on the matching circuit will be provided according to the customer's installation conditions.



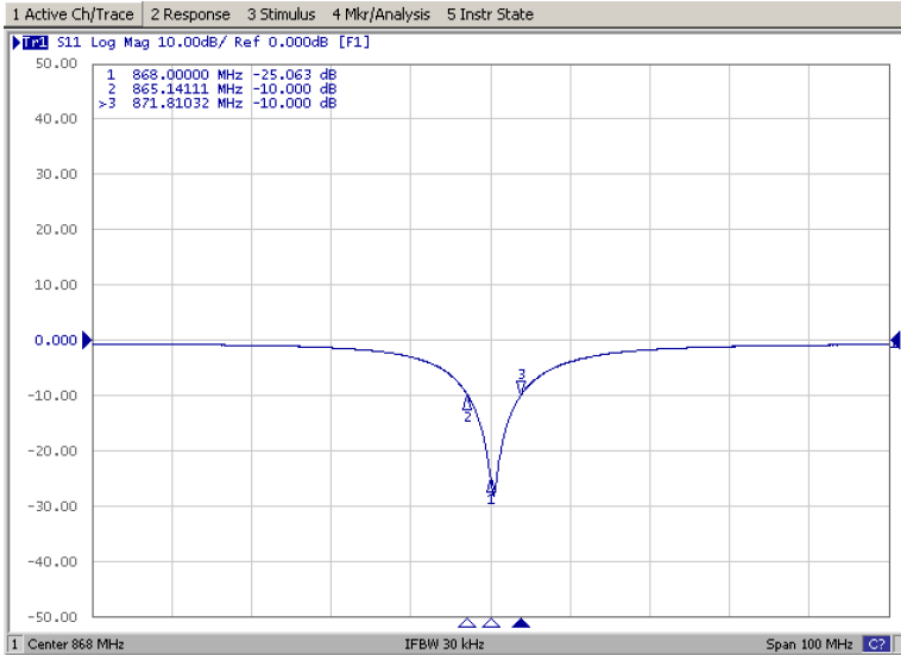
### Soldering Conditions



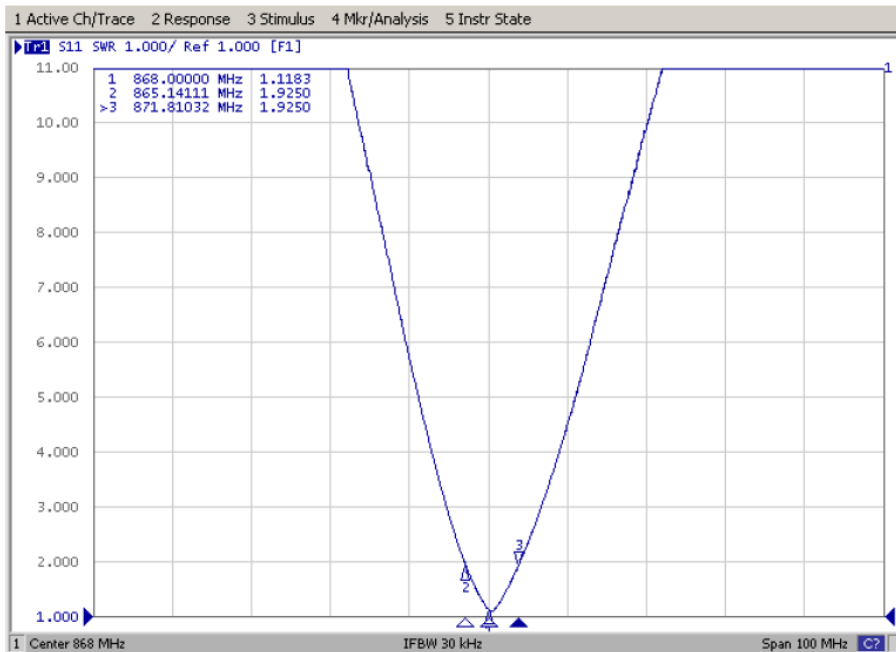
\* Recommended solder paste alloy: SAC305 (Sn96.5 /Ag3 /Cu0.5) Lead Free solder paste.



### Return Loss ( $S_{11}$ )

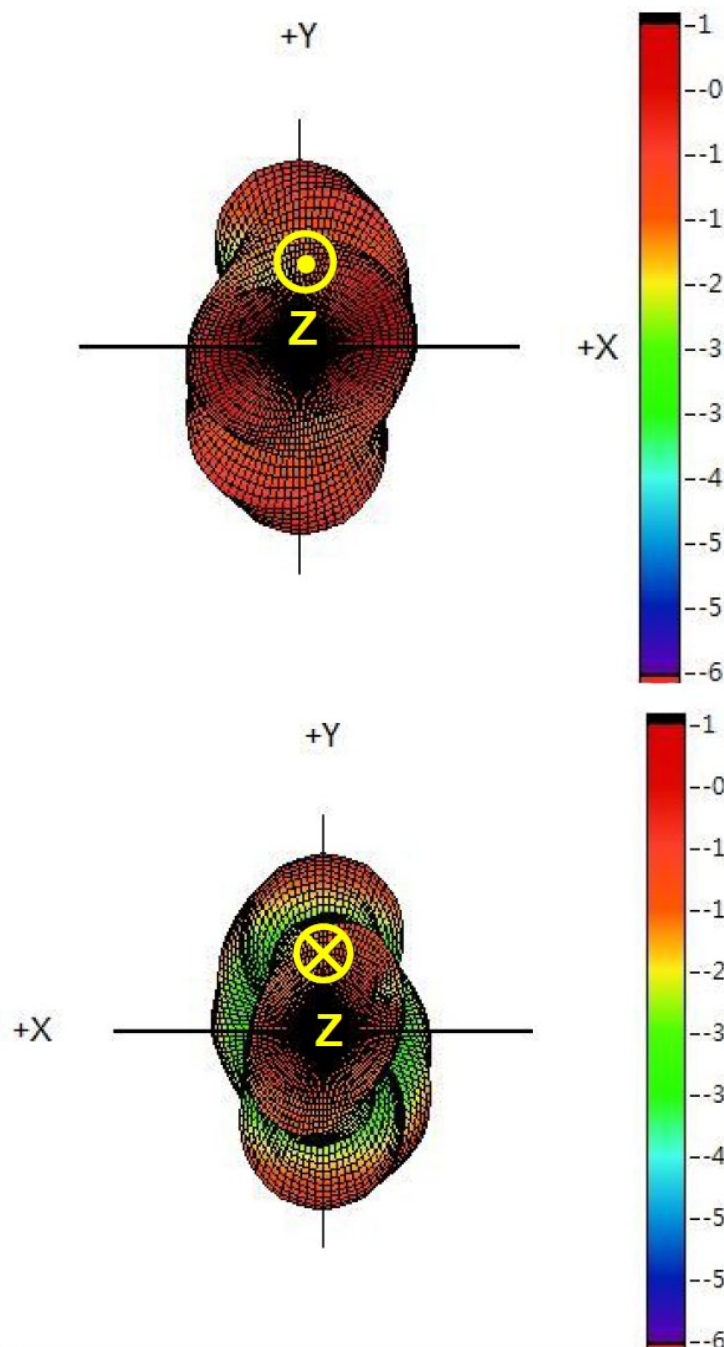


### VSWR ( $S_{11}$ )



### Antenna Radiation Pattern

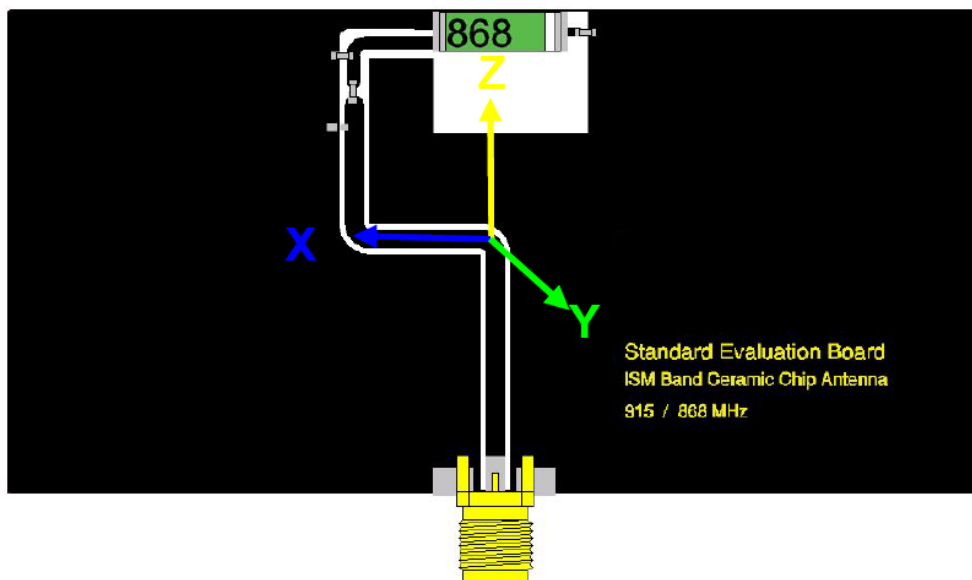
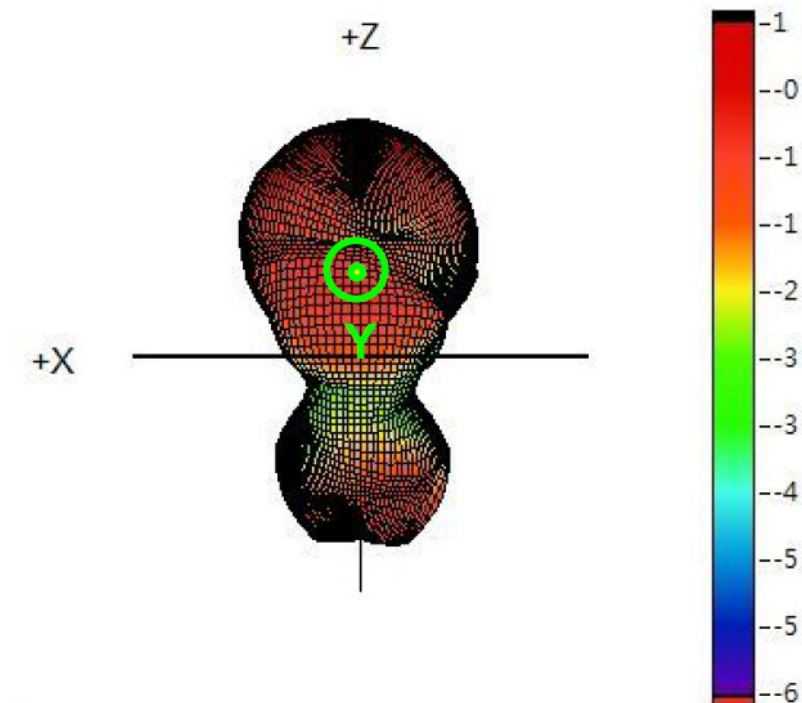
#### 3D Gain Radiation @ 868 MHz





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868 MHz ISM Chip Antenna



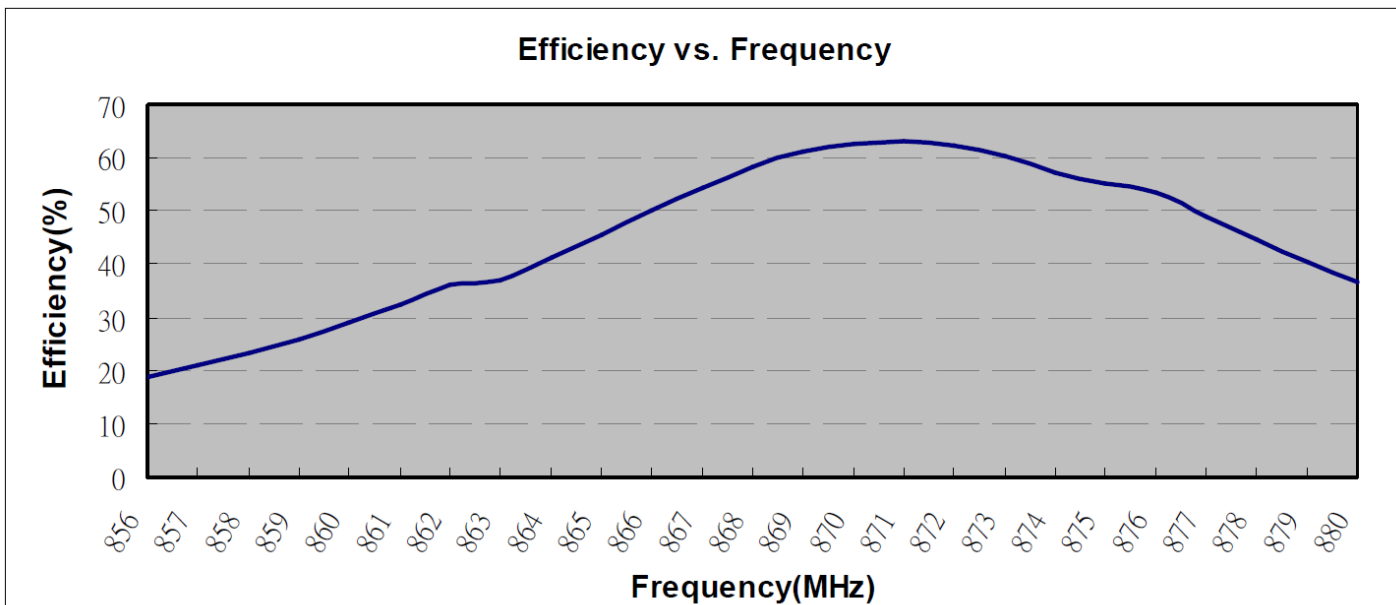


### 3D Efficiency Table

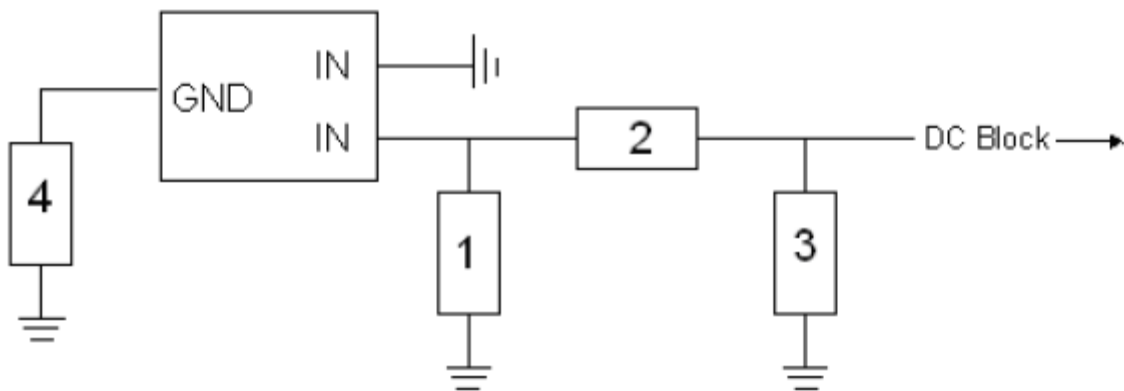
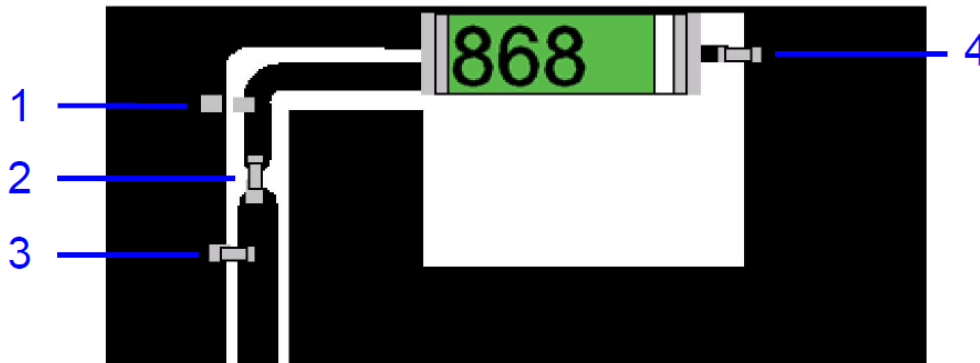
Frequency (MHz)	856	857	858	859	860	861	862	863	864	865	866	867	868
Efficiency (dB)	-7.3	-6.8	-6.3	-5.9	-5.4	-4.9	-4.4	-4.3	-3.8	-3.4	-3.0	-2.6	-2.4
Efficiency (%)	18.9	20.9	23.3	26.0	29.0	32.4	36.1	37.1	41.3	45.6	50.1	54.4	58.3
Gain (dBi)	-4.6	-4.3	-3.9	-3.4	-2.6	-2.2	-1.9	-1.6	-1.0	-0.7	-0.2	0.2	0.3

Frequency (MHz)	869	870	871	872	873	874	875	876	877	878	879	880
Efficiency (dB)	-2.1	-2.0	-2.0	-2.1	-2.2	-2.4	-2.6	-2.7	-3.1	-3.5	-3.9	-4.4
Efficiency (%)	61.2	62.7	63.2	62.3	60.2	57.2	55.2	53.6	49.0	44.6	40.5	36.7
Gain (dBi)	0.3	0.2	0.2	0.2	0.1	-0.1	-0.1	-0.2	-0.5	-0.9	-1.3	-1.8

### 3D Efficiency vs Frequency



### Matching Circuit



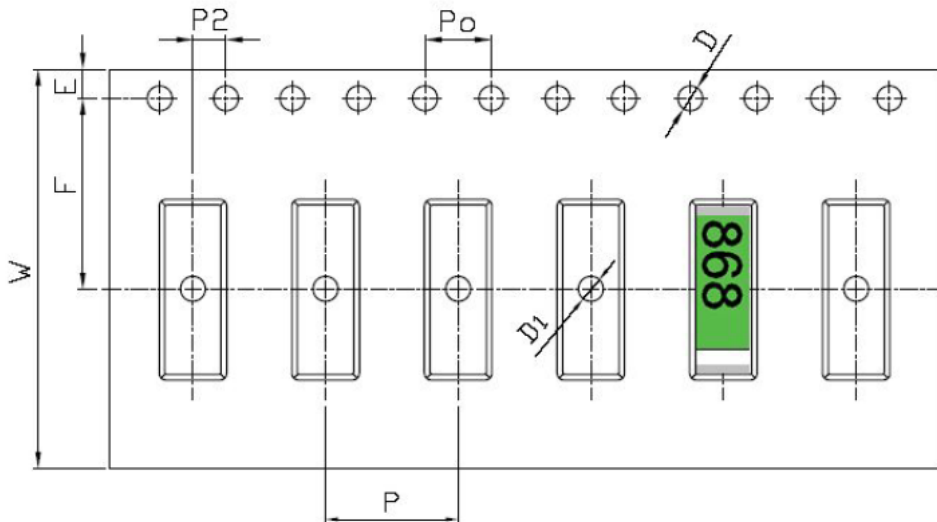
### System Matching Circuit Component

Location	Description	Tolerance	NIC Part Number
1	N/A	-	-
2	0Ω, (0402)	-	<a href="#">NRC04Z0TRF</a>
3	3.3pF, (0402)	±0.05pF	<a href="#">NMC-Q0402NPO3R3A50TRPF</a>
4	12pF, (0402)	±5%	<a href="#">NMC-Q0402NPO120J50TRPF</a>

### Packing

- (1) Quantity/Reel: 6000 pcs/Reel
- (2) Unit Weight:  $0.05 \pm 0.005$  g / pcs
- (3) Plastic tape: Black Conductive Polystyrene.

### a. Tape Drawing



### b. Tape Dimensions (unit: mm)

Feature	Specifications	Tolerances
W	24.00	$\pm 0.30$
P	8.00	$\pm 0.10$
E	1.75	$\pm 0.10$
F	11.50	$\pm 0.10$
P2	2.00	$\pm 0.10$
D	1.50	$^{+0.10}$ $_{0.00}$
D1	1.50	$\pm 0.10$
Po	4.00	$\pm 0.10$
10Po	40.00	$\pm 0.20$